

Understanding EEPROM Programming for High Speed Repeaters and Mux Buffers

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ABSTRACT

System designers often use EEPROM (Electrically Erasable Programmable Read-Only Memory) to program a set of customized high speed repeater and mux buffer start-up settings that are different from the default. Using the information here will make repeater EEPROM configuration and programming easy to implement and understand. This application note addresses SMBus-to-EEPROM mapping for 2-channel repeaters, 8-channel repeaters (8-channel uni-directional and 4-lane bi-directional), and 2:1/1:2 mux buffers. In addition, this application note provides guidance and several examples regarding how to read the Intel hex file format as it relates to each programmed TI device. With a complete understanding of how to program and interpret EEPROM hex files for TI's 2-channel repeaters, 8-channel repeaters, and 2:1/1:2 mux buffers, system designers are better equipped to generate their own customized hex files and increase the efficiency of their final designs. The information in this Application Report applies to the DS80PC1xxx, DS100BRxxx, and DS125BRxxx drivers as well as the DS100MB203 and DS125MB203 mux buffers.

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1 Introduction

EEPROM is non-volatile memory used in electronic devices to store data that must be saved when power is removed. This non-volatile memory is particularly important when an application requires different start-up configurations than the factory default settings. Upon device power-up, data saved in the EEPROM will load automatically to the device. If EEPROM is not used, interface system designs require external access to the SMBus SDA and SCL lines in order to set individual registers after each power-up. With EEPROM, designers eliminate the requirement for an external microprocessor or software driver to provide their desired register settings.

Programming EEPROM for TI's high speed repeaters requires an understanding of how EEPROM relates to the high speed repeater Slave Mode SMBus registers. When generating EEPROM hex images for one of TI's high speed repeaters, the following must be considered:

- Users must map EEPROM address bits correctly to the matching device SMBus register bits. Note that only a subset of SMBus register settings are mapped to EEPROM.
- The contents of an EEPROM are typically stored in Intel hex-file format. The format at times can appear cryptic, especially when multiple devices are programmed to the EEPROM.
- Programming multiple device slots requires either two or three additional address map header bytes per device to denote the CRC and starting address of each device slot.

To address these design challenges, this application note explains how to map SMBus registers to EEPROM addresses, how to interpret the Intel hex file format, and how to program EEPROM data for multiple devices.

2 EEPROM Physical Configuration

EEPROM programming depends on the number of repeaters that share the same SMBus interface. It is therefore important to understand how an EEPROM is configured to interface with TI's repeaters and mux buffers. The following subsections provide insight about EEPROM connections for single and multiple devices.

2.1 EEPROM Configuration for Single Device

A simplified block diagram of EEPROM connected to a single device is shown in Figure 1. If a single device operates in SMBus Master Mode, the EEPROM loads specific SMBus register bits into the device when $\overline{\text{READ_EN}}$ is asserted low. While data is loading to the device, the device operates as a master over the bus and requests data from the EEPROM. Once the EEPROM contents are successfully read, the $\overline{\text{ALL_DONE}}$ pin asserts low. In most repeater and mux buffer EVMs, an LED is attached to the $\overline{\text{ALL_DONE}}$ pin to notify that a successful read has occurred. Once the $\overline{\text{ALL_DONE}}$ pin asserts low, the device releases control of the bus and resumes operation in SMBus slave mode. At this point, an optional external SMBus control MCU master may be used for any additional programming or monitoring, though it is not required.

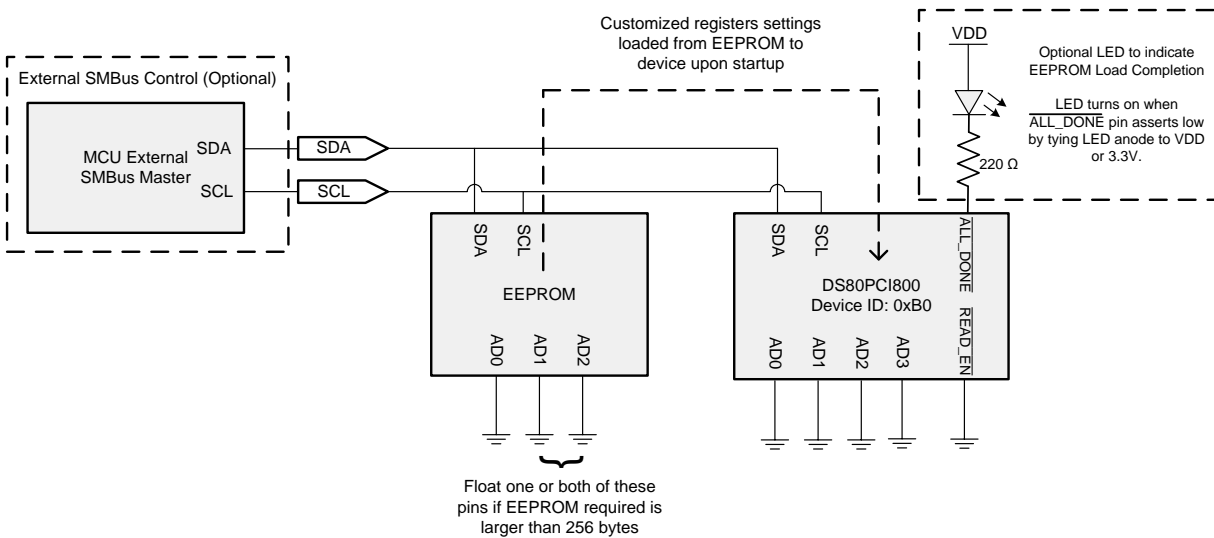


Figure 1. Example of EEPROM Used to Program a Single DS80PCI800

2.2 EEPROM Configuration for Multiple Devices

The sequential behavior in which the `READ_EN` and `ALL_DONE` pins function are ideal for systemically programming EEPROM contents to multiple devices that share the same SMBus lines. By asserting the `READ_EN` pin of the first device low, the EEPROM will load the first device's contents into the first device. During this time, no other device can take control of the SMBus lines until this first device finishes and asserts its `ALL_DONE` pin low. Therefore, the `ALL_DONE` pin of the first device can be tied directly to the `READ_EN` pin of the second device in the sequence to indicate when the second device can take control of the SMBus lines. This daisy chain process continues until the last device loads its settings from the EEPROM successfully. Daisy chaining is a recommended practice for loading EEPROM settings to multiple devices connected to the same SMBus lines, and this implementation prevents bus contention that can occur when two devices try to read from the EEPROM simultaneously.

A simplified block diagram of EEPROM connected to multiple devices is shown in Figure 2. In this example, there are 5 x DS80PCI800 repeaters. Note how daisy chaining is used to implement sequential EEPROM loading.

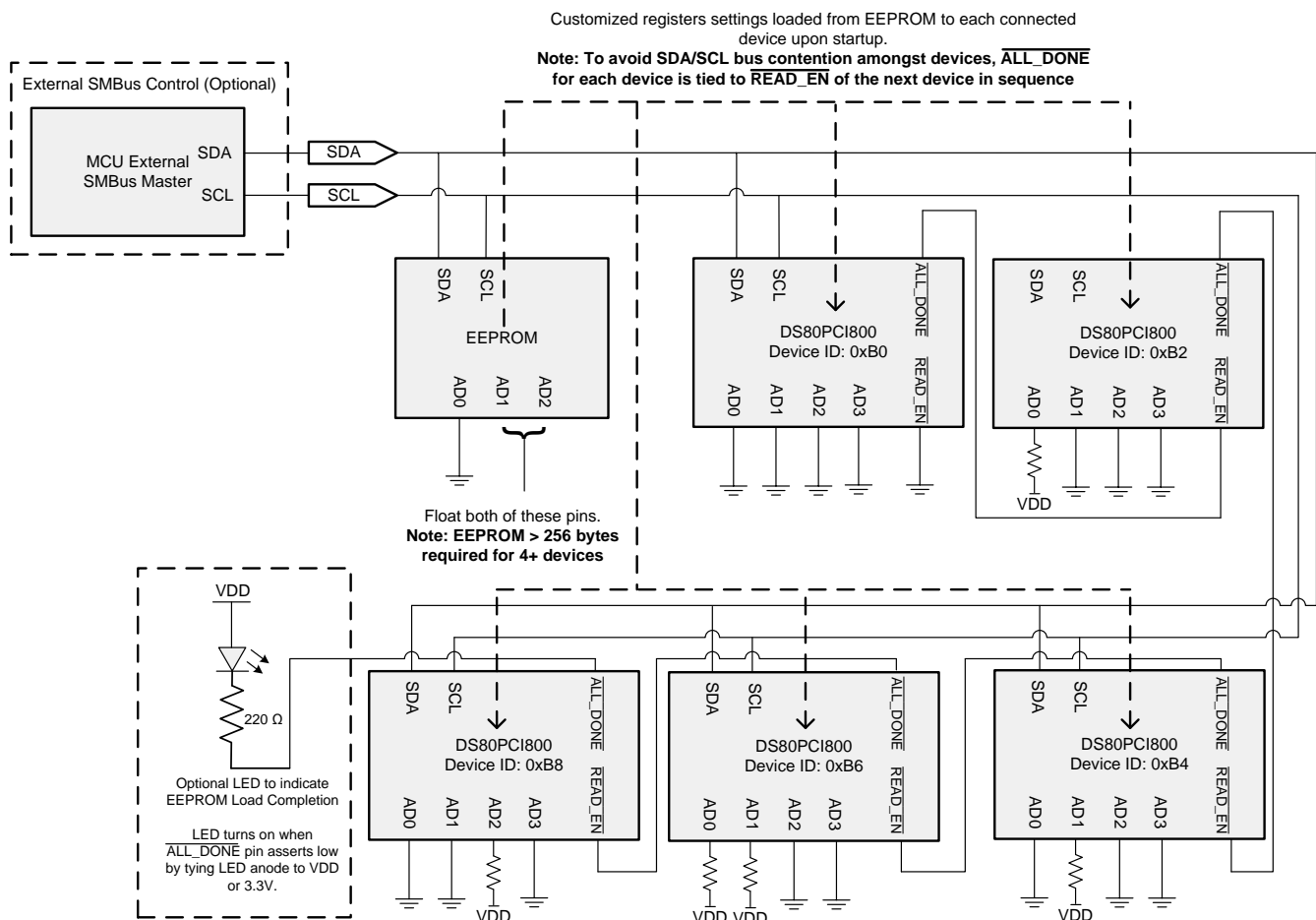


Figure 2. Example of EEPROM Used to Program Five DS80PCI800 Devices

3 SMBus-to-EEPROM Mapping

When populating EEPROM addresses, it is important to understand how the device SMBus Slave registers map to the EEPROM. The EEPROM only takes a subset of the SMBus register bits. SMBus register bits that are not stored in EEPROM cannot be changed from default at device startup. A table of the DS125BR401A SMBus-to-EEPROM mapping is shown in [Table 1](#).

To read the table, the blue column represents the EEPROM address byte, while columns 2-9 show Bits 7:0 for the corresponding EEPROM address. The matching SMBus register bit for each EEPROM address bit is shown in green, and the respective default value for that bit is shown in the row directly below. For example, EEPROM Address 0x05[4] maps to SMBus Slave Mode Reg 0x04[1], where the default value is 0, while EEPROM Address 0x06[2] maps to SMBus Slave Mode Reg 0x0B[6], where the default value is 1.

Though TI's 2-channel repeaters, 8-channel repeaters, and 2:1/1:2 mux buffers differ from one another regarding the function description of each specific SMBus register bit, they all share the same SMBus-to-EEPROM register bit-to-bit mapping.

NOTE: The first three bytes of the EEPROM always contain a base header to control initialization of all devices connected to the same SMBus lines.

Table 1. EEPROM Address Map from DS125BR401A - Single Device with Default Value

EEPROM Address Byte		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Description	0 (0x00)	CRC_EN	ADDR Map Present	EEPROM > 256 Bytes	Reserved	DEVICE COUNT [3]	DEVICE COUNT [2]	DEVICE COUNT [1]	DEVICE COUNT [0]
Default Value		0	0	0	0	0	0	0	0
Description	1 (0x01)	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
Default Value		0	0	0	0	0	0	0	0
Description	2 (0x02)	Max EEPROM	Max EEPROM	Max EEPROM	Max EEPROM	Max EEPROM	Max EEPROM	Max EEPROM	Max EEPROM
Default Value		Burst size [7]	Burst size [6]	Burst size [5]	Burst size [4]	Burst size [3]	Burst size [2]	Burst size [1]	Burst size [0]
Description	3 (0x03)	PWDN_CH7	PWDN_CH6	PWDN_CH5	PWDN_CH4	PWDN_CH3	PWDN_CH2	PWDN_CH1	PWDN_CH0
SMBus Register		0x01 [7]	0x01 [6]	0x01 [5]	0x01 [4]	0x01 [3]	0x01 [2]	0x01 [1]	0x01 [0]
Default Value	0	0	0	0	0	0	0	0	
Description	4 (0x04)	Reserved	Reserved	Reserved	Reserved	OVRD_PWDN	CH7_EQ_LIM	CH6_EQ_LIM	CH5_EQ_LIM
SMBus Register		0x02 [5]	0x02 [4]	0x02 [3]	0x02 [2]	0x02 [0]	0x04 [7]	0x04 [6]	0x04 [5]
Default Value	0	0	0	0	0	0	0	0	
Description	5 (0x05)	CH4_EQ_LIM	CH3_EQ_LIM	CH2_EQ_LIM	CH1_EQ_LIM	CH0_EQ_LIM	Reserved	OVRD_SD_TH	Reserved
SMBus Register		0x04 [4]	0x04 [3]	0x04 [2]	0x04 [1]	0x04 [0]	0x06 [4]	0x08 [6]	0x08 [5]
Default Value	0	0	0	0	0	1	0	0	
Description	6 (0x06)	OVRD_IDLE	OVRD_RX_DET	OVRD_MODE_B	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x08 [4]	0x08 [3]	0x08 [2]	0x08 [1]	0x08 [0]	0x0B [6]	0x0B [5]	0x0B [4]
Default Value	0	0	0	0	0	1	1	1	
Description	7 (0x07)	Reserved	Reserved	Reserved	Reserved	CH0_IDLE_AUTO	CH0_IDLE_SEL	CH0_RXDET_1	CH0_RXDET_0
SMBus Register		0x0B [3]	0x0B [2]	0x0B [1]	0x0B [0]	0x0E [5]	0x0E [4]	0x0E [3]	0x0E [2]
Default Value	0	0	0	0	0	0	0	0	
Description	8 (0x08)	CH0_EQ_7	CH0_EQ_6	CH0_EQ_5	CH0_EQ_4	CH0_EQ_3	CH0_EQ_2	CH0_EQ_1	CH0_EQ_0
SMBus Register		0x0F [7]	0x0F [6]	0x0F [5]	0x0F [4]	0x0F [3]	0x0F [2]	0x0F [1]	0x0F [0]
Default Value	0	0	1	0	1	1	1	1	
Description	9 (0x09)	CH0_SCP	CH0_MODE	Reserved	Reserved	Reserved	CH0_VOD_2	CH0_VOD_1	CH0_VOD_0
SMBus Register		0x10 [7]	0x10 [6]	0x10 [5]	0x10 [4]	0x10 [3]	0x10 [2]	0x10 [1]	0x10 [0]
Default Value	1	0	1	0	1	1	0	1	
Description	10 (0x0A)	CH0_DEM_2	CH0_DEM_1	CH0_DEM_0	Reserved	CH0_IDLE_THA_1	CH0_IDLE_THA_0	CH0_IDLE_THD_1	CH0_IDLE_THD_0
SMBus Register		0x11 [2]	0x11 [1]	0x11 [0]	0x12 [7]	0x12 [3]	0x12 [2]	0x12 [1]	0x12 [0]
Default Value	0	1	0	0	0	0	0	0	
Description	11 (0x0B)	CH1_IDLE_AUTO	CH1_IDLE_SEL	CH1_RXDET_1	CH1_RXDET_0	CH1_EQ_7	CH1_EQ_6	CH1_EQ_5	CH1_EQ_4
SMBus Register		0x15 [5]	0x15 [4]	0x15 [3]	0x15 [2]	0x16 [7]	0x16 [6]	0x16 [5]	0x16 [4]
Default Value	0	0	0	0	0	0	1	0	
Description	12 (0x0C)	CH1_EQ_3	CH1_EQ_2	CH1_EQ_1	CH1_EQ_0	CH1_SCP	CH1_MODE	Reserved	Reserved
SMBus Register		0x16 [3]	0x16 [2]	0x16 [1]	0x16 [0]	0x17 [7]	0x17 [6]	0x17 [5]	0x17 [4]
Default Value	1	1	1	1	1	0	1	0	
Description	13 (0x0D)	Reserved	CH1_VOD_2	CH1_VOD_1	CH1_VOD_0	CH1_DEM_2	CH1_DEM_1	CH1_DEM_0	Reserved
SMBus Register		0x17 [3]	0x17 [2]	0x17 [1]	0x17 [0]	0x18 [2]	0x18 [1]	0x18 [0]	0x19 [7]
Default Value	1	1	0	1	0	1	0	0	

Table 1. EEPROM Address Map from DS125BR401A - Single Device with Default Value (continued)

EEPROM Address Byte		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Description	14 (0x0E)	CH1_IDLE_THA_1	CH1_IDLE_THA_0	CH1_IDLE_THD_1	CH1_IDLE_THD_0	CH2_IDLE_AUTO	CH2_IDLE_SEL	Reserved	Reserved
SMBus Register		0x19 [3]	0x19 [2]	0x19 [1]	0x19 [0]	0x1C [5]	0x1C [4]	0x1C [3]	0x1C [2]
Default Value		0x00	0	0	0	0	0	0	0
Description	15 (0x0F)	CH2_EQ_7	CH2_EQ_6	CH2_EQ_5	CH2_EQ_4	CH2_EQ_3	CH2_EQ_2	CH2_EQ_1	CH2_EQ_0
SMBus Register		0x1D [7]	0x1D [6]	0x1D [5]	0x1D [4]	0x1D [3]	0x1D [2]	0x1D [1]	0x1D [0]
Default Value		0x2F	0	0	1	0	1	1	1
Description	16 (0x10)	CH2_SCP	CH2_MODE	Reserved	Reserved	Reserved	CH2_VOD_2	CH2_VOD_1	CH2_VOD_0
SMBus Register		0x1E [7]	0x1E [6]	0x1E [5]	0x1E [4]	0x1E [3]	0x1E [2]	0x1E [1]	0x1E [0]
Default Value		0xAD	1	0	1	0	1	0	1
Description	17 (0x11)	CH2_DEM_2	CH2_DEM_1	CH2_DEM_0	Reserved	CH2_IDLE_THA_1	CH2_IDLE_THA_0	CH2_IDLE_THD_1	CH2_IDLE_THD_0
SMBus Register		0x1F [2]	0x1F [1]	0x1F [0]	0x20 [7]	0x20 [3]	0x20 [2]	0x20 [1]	0x20 [0]
Default Value		0x40	0	1	0	0	0	0	0
Description	18 (0x12)	CH3_IDLE_AUTO	CH3_IDLE_SEL	CH3_RXDET_1	CH3_RXDET_0	CH3_EQ_7	CH3_EQ_6	CH3_EQ_5	CH3_EQ_4
SMBus Register		0x23 [5]	0x23 [4]	0x23 [3]	0x23 [2]	0x24 [7]	0x24 [6]	0x24 [5]	0x24 [4]
Default Value		0x02	0	0	0	0	0	1	0
Description	19 (0x13)	CH3_EQ_3	CH3_EQ_2	CH3_EQ_1	CH3_EQ_0	CH3_SCP	CH3_MODE	Reserved	Reserved
SMBus Register		0x24 [3]	0x24 [2]	0x24 [1]	0x24 [0]	0x25 [7]	0x25 [6]	0x25 [5]	0x25 [4]
Default Value		0xFA	1	1	1	1	1	0	1
Description	20 (0x14)	Reserved	CH3_VOD_2	CH3_VOD_1	CH3_VOD_0	CH3_DEM_2	CH3_DEM_1	CH3_DEM_0	Reserved
SMBus Register		0x25 [3]	0x25 [2]	0x25 [1]	0x25 [0]	0x26 [2]	0x26 [1]	0x26 [0]	0x27 [7]
Default Value		0xD4	1	1	0	1	0	1	0
Description	21 (0x15)	CH3_IDLE_THA_1	CH3_IDLE_THA_0	CH3_IDLE_THD_1	CH3_IDLE_THD_0	OVRD_FAST_IDLE	HI_IDLE_TH_CH0-3	HI_IDLE_TH_CH4-7	FAST_IDLE_CH0-3
SMBus Register		0x27 [3]	0x27 [2]	0x27 [1]	0x27 [0]	0x28 [6]	0x28 [5]	0x28 [4]	0x28 [3]
Default Value		0x09	0	0	0	0	1	0	0
Description	22 (0x16)	FAST_IDLE_CH4-7	LO_GAIN_CH0-3	LO_GAIN_CH4-7	CH4_IDLE_AUTO	CH4_IDLE_SEL	CH4_RXDET_1	CH4_RXDET_0	Reserved
SMBus Register		0x28 [2]	0x28 [1]	0x28 [0]	0x2B [5]	0x2B [4]	0x2B [3]	0x2B [2]	0x2C [7]
Default Value		0x80	1	0	0	0	0	0	0
Description	23 (0x17)	Reserved	Reserved	Reserved	Reserved	Reserved	CH4_EQ_1	CH4_EQ_0	CH4_SCP
SMBus Register		0x2C [6]	0x2C [5]	0x2C [4]	0x2C [3]	0x2C [2]	0x2C [1]	0x2C [0]	0x2D [7]
Default Value		0x5F	0	1	0	1	1	1	1
Description	24 (0x18)	Reserved	Reserved	Reserved	Reserved	CH4_VOD_2	CH4_VOD_1	CH4_VOD_0	CH4_DEM_2
SMBus Register		0x2D [6]	0x2D [5]	0x2D [4]	0x2D [3]	0x2D [2]	0x2D [1]	0x2D [0]	0x2E [2]
Default Value		0x5A	0	1	0	1	1	0	1
Description	25 (0x19)	CH4_DEM_1	CH4_DEM_0	Reserved	CH4_IDLE_THA_1	CH4_IDLE_THA_0	CH4_IDLE_THD_1	CH4_IDLE_THD_0	CH5_IDLE_AUTO
SMBus Register		0x2E [1]	0x2E [0]	0x2F [7]	0x2F [3]	0x2F [2]	0x2F [1]	0x2F [0]	0x32 [5]
Default Value		0x80	1	0	0	0	0	0	0
Description	26 (0x1A)	CH5_IDLE_SEL	CH5_RXDET_1	CH5_RXDET_0	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x32 [4]	0x32 [3]	0x32 [2]	0x33 [7]	0x33 [6]	0x33 [5]	0x33 [4]	0x33 [3]
Default Value		0x05	0	0	0	0	0	1	0

Table 1. EEPROM Address Map from DS125BR401A - Single Device with Default Value (continued)

EEPROM Address Byte		Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
Description	27 (0x1B)	Reserved	CH5_EQ_1	CH5_EQ_0	CH5_SCP	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x33 [2]	0x33 [1]	0x33 [0]	0x34 [7]	0x34 [6]	0x34 [5]	0x34 [4]	0x34 [3]
Default Value		0xF5	1	1	1	1	0	1	0
Description	28 (0x1C)	CH5_VOD_2	CH5_VOD_1	CH5_VOD_0	CH5_DEM_2	CH5_DEM_1	CH5_DEM_0	Reserved	CH5_IDLE_THA_1
SMBus Register		0x34 [2]	0x34 [1]	0x34 [0]	0x35 [2]	0x35 [1]	0x35 [0]	0x36 [7]	0x36 [3]
Default Value		0xA8	1	0	1	0	1	0	0
Description	29 (0x1D)	CH5_IDLE_THA_0	CH5_IDLE_THD_1	CH5_IDLE_THD_0	CH6_IDLE_AUTO	CH6_IDLE_SEL	CH6_RXDET_1	CH6_RXDET_0	Reserved
SMBus Register		0x36 [2]	0x36 [1]	0x36 [0]	0x39 [5]	0x39 [4]	0x39 [3]	0x39 [2]	0x3A [7]
Default Value		0x00	0	0	0	0	0	0	0
Description	30 (0x1E)	Reserved	Reserved	Reserved	Reserved	Reserved	CH6_EQ_1	CH6_EQ_0	CH6_SCP
SMBus Register		0x3A [6]	0x3A [5]	0x3A [4]	0x3A [3]	0x3A [2]	0x3A [1]	0x3A [0]	0x3B [7]
Default Value		0x5F	0	1	0	1	1	1	1
Description	31 (0x1F)	Reserved	Reserved	Reserved	Reserved	CH6_VOD_2	CH6_VOD_1	CH6_VOD_0	CH6_DEM_2
SMBus Register		0x3B [6]	0x3B [5]	0x3B [4]	0x3B [3]	0x3B [2]	0x3B [1]	0x3B [0]	0x3C [2]
Default Value		0x5A	0	1	0	1	1	0	1
Description	32 (0x20)	CH6_DEM_1	CH6_DEM_0	Reserved	CH6_IDLE_THA_1	CH6_IDLE_THA_0	CH6_IDLE_THD_1	CH6_IDLE_THD_0	CH7_IDLE_AUTO
SMBus Register		0x3C [1]	0x3C [0]	0x3D [7]	0x3D [3]	0x3D [2]	0x3D [1]	0x3D [0]	0x40 [5]
Default Value		0x80	1	0	0	0	0	0	0
Description	33 (0x21)	CH7_IDLE_SEL	CH7_RXDET_1	CH7_RXDET_0	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x40 [4]	0x40 [3]	0x40 [2]	0x41 [7]	0x41 [6]	0x41 [5]	0x41 [4]	0x41 [3]
Default Value		0x05	0	0	0	0	1	0	1
Description	34 (0x22)	Reserved	CH7_EQ_1	CH7_EQ_0	CH7_SCP	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x41 [2]	0x41 [1]	0x41 [0]	0x42 [7]	0x42 [6]	0x42 [5]	0x42 [4]	0x42 [3]
Default Value		0xF5	1	1	1	1	0	1	0
Description	35 (0x23)	CH7_VOD_2	CH7_VOD_1	CH7_VOD_0	CH7_DEM_2	CH7_DEM_1	CH7_DEM_0	Reserved	CH7_IDLE_THA_1
SMBus Register		0x42 [2]	0x42 [1]	0x42 [0]	0x43 [2]	0x43 [1]	0x43 [0]	0x44 [7]	0x44 [3]
Default Value		0xA8	1	0	1	0	1	0	0
Description	36 (0x24)	CH7_IDLE_THA_0	CH7_IDLE_THD_1	CH7_IDLE_THD_0	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x44 [2]	0x44 [1]	0x44 [0]	0x47 [3]	0x47 [2]	0x47 [1]	0x47 [0]	0x48 [7]
Default Value		0x00	0	0	0	0	0	0	0
Description	37 (0x25)	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x48 [6]	0x4C [7]	0x4F [6]	0x4C [5]	0x4C [4]	0x4C [3]	0x4C [0]	0x59 [0]
Default Value		0x00	0	0	0	0	0	0	0
Description	38 (0x26)	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x5A [7]	0x5A [6]	0x5A [5]	0x5A [4]	0x5A [3]	0x5A [2]	0x5A [1]	0x5A [0]
Default Value		0x54	0	1	0	1	0	1	0
Description	39 (0x27)	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved
SMBus Register		0x5B [7]	0x5B [6]	0x5B [5]	0x5B [4]	0x5B [3]	0x5B [2]	0x5B [1]	0x5B [0]
Default Value		0x54	0	1	0	1	0	1	0

5 EEPROM Device Data Fundamentals

Each repeater and mux buffer EEPROM file contains one base header. Depending on the system design, a CRC and address map header may also be used after the base header. A detailed explanation about the contents of these headers and other key fundamentals are discussed in the subsections below.

5.1 Base Header

The first three bytes define the Base Header. The meaning of the first three bytes is explained in [Table 2](#).

Table 2. Base Header Information

BYTE	BIT NO.	BIT NAME	DESCRIPTION
0	7	CRC_EN	1 = CRC enable. If enabled, each device will have a CRC value specific to the base header (3 bytes), address map header (2 or 3 bytes, if applicable), and data (37 bytes). 0 = CRC disabled. If disabled, the CRC value is not computed, and CRC checking is ignored.
	6	ADDR Map Enable	1 = Address Map Header enable. If enabled, a 2 or 3 byte address map header will be placed after the base header to indicate the start address of each device's EEPROM. 0 = Address Map Header disable. If disabled, the first device's EEPROM information will immediately follow the base header.
	5	EEPROM > 256 Bytes	1 = Required EEPROM size is more than 256 bytes. This is necessary if there are more than 4 EEPROM slots. 0 = Required EEPROM size is 256 bytes or less. This value indicates that up to 4 EEPROM slots can be programmed.
	4	RES	Reserved. Set bit to 0.
	3:0	DEVICE COUNT	DEVICE COUNT = (Total number of Devices) - 1 Note: This value is not used by the device when the EEPROM loads data, though it is a useful debugging reference.
1	7:0	RES	Reserved. Set bits to 0.
2	7:0	Max EEPROM Burst Size	Maximum number of bytes that are read during a burst read operation. A value of 0x10 is suitable for all EEPROMs using TI's high speed repeaters and mux buffers.

5.2 Address Map Header

When multiple devices are used, address map headers are necessary. In order to assign the correct EEPROM data to the correct device, each device must know the location where it can obtain the correct register settings. Details about where this information exists in the address map header are given in [Table 3](#).

Table 3. Address Map Header Information

BYTE	BIT NO.	BIT NAME	DESCRIPTION
0	7:0	CRC Value	8-Bit CRC value for each device. CRC is computed from the base header (3 bytes), address map header (2 or 3 bytes, if applicable), and EEPROM data specific to the device (37 bytes).
1	7:0	Device EEPROM Start Address	Start address for device-specific EEPROM data. Recall that Address 0x00-0x02 of device EEPROM is stored in the base header.
2	7:0	RES	Reserved. Set bits to 0.
	2:0	Device EEPROM Start Address MSBs	These bits are only set if EEPROM Size > 256 bytes. Up to 3 MSB bits can be appended to the front of the EEPROM start address indicated in Byte 1.

NOTE: Byte 2 is present only if EEPROM > 256 bytes, as indicated by asserting Base Header Address 0x00[5] = 1. For example, if the EEPROM start address is located at Address 0x1F4, 9 bits are required. Thus, Address Map Header Byte 1 = 0xF4, and Address Map Header Byte 2 = 0x01. If EEPROM ≤ 256 bytes, then the address map header will be 2 bytes, not 3 bytes.

5.3 Cyclic Redundancy Check (CRC) Calculation

Sometimes, systems require a CRC check to ensure communication integrity between EEPROM and target device. When the CRC is enabled in the Base Header (Address 0x00[7] = 1), each device programmed by the EEPROM will have a specific CRC value in its respective Address Map Header Byte 0. The CRC is calculated via the CRC-8 polynomial, where the input $x = [\text{Base Header (3 Bytes)} + \text{Address Map header (1 or 2 Bytes)} + \text{Device Data (37 Bytes)}]$. An example is provided below:

Table 4. EEPROM CRC-8 Example

Section	Value (Hex)
Base Header	0xC00010
Address Map Header	0x23
Device Data	0x000004070000AA80000AA80000AA80000AA8 00800155000015500001550000155000005454
CRC-8 Input	0xC0001023000004070000AA80000AA80000AA8000 0AA800800155000015500001550000155000005454
Computed CRC-8 (Address Map Header Byte 0)	0xB6

5.4 Number of Devices versus Number of Slots

There is an important distinction between the number of devices and the number of slots. The number of devices pertains to the total number of physical devices present on the line. A maximum of 16 devices can be programmed from the EEPROM. However, the number of slots pertains to the total number of unique SMBus register settings to load from the EEPROM. Thus, the required size of the EEPROM depends more on the number of unique EEPROM slots that are used compared to the number of devices that will be programmed.

Oftentimes, multiple devices share the same SMBus register settings. If multiple devices share the exact same SMBus register settings, then they can share the same EEPROM slot. In contrast, if different register settings are required for any of the devices connected to the same EEPROM, each different set of SMBus register settings will require its own EEPROM slot.

The base header bytes are 0x6B0010. From [Table 2](#), the following is derived:

- CRC is disabled (Address 0x00[7] = 0'b).
- Address map header is enabled (Address 0x00[6] = 1'b).
- EEPROM > 256 bytes (Address 0x00[5] = 1'b).
- DEVICE COUNT = 12 Devices (Address 0x00[3:0] = 1011'b).
- Max EEPROM Burst size = 16 bytes (Address 0x02 = 0x10).

Since CRC is disabled, each Address Map Header Byte 0 is 0x00. In this example, Device 10 and Device 11 share the same address map header. This occurs if multiple devices are programmed with identical SMBus register settings.

There are 10 unique address map headers for 11 devices. Unlike the previous examples, the address map header here has 3 bytes, since the EEPROM > 256 bytes. Recall that when the address map header is 3 bytes, the 3 LSBs of the Address Map Header Byte 2 become the 3 MSBs of the EEPROM start address. Thus, from [Table 3](#), the following is derived:

- Device 0 [Start Address] = 0x33
- Device 1 [Start Address] = 0x58
- Device 2 [Start Address] = 0x7D
- Device 3 [Start Address] = 0xA2
- Device 4 [Start Address] = 0xC7
- Device 5 [Start Address] = 0xEC
- Device 6 [Start Address] = 0x111
- Device 7 [Start Address] = 0x136
- Device 8 [Start Address] = 0x15B
- Device 9 [Start Address] = 0x180
- Device 10 [Start Address] = 0x1A5
- Device 11 [Start Address] = 0x1A5

By searching for the start address relevant to each device the remaining 37 bytes that are used to program the device can be found. For example, in Device 6, the 37 bytes of device data begin at EEPROM Address 0x111.

9 Summary

In this application note, the benefits of EEPROM are explored as they relate to TI's high speed 2-channel repeaters, 8-channel repeaters, and 2:1/1:2 mux buffers. Device-specific EEPROM concepts such as the Base Header, Address Map Header, CRC, and EEPROM data slot are explained in detail. In addition, the requirements of Intel hex format are revealed to help users differentiate between EEPROM sections relevant to formatting and EEPROM sections relevant to the device settings. With a complete understanding of how to program and interpret these EEPROM hex files, system designers are better equipped to generate their own customized hex files and increase the efficiency of their final designs.

10 References

1. "Intel Hexadecimal Object File Format Specification", Revision A, 1/6/88.
2. DS80PCI800 Datasheet ([SNLS334](#))
3. DS125BR401A Datasheet ([SNLS466](#))

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